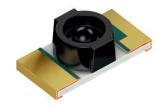
SFH 4056

CHIPLED® Lens

High Power Infrared Emitter (850 nm)





Applications

- Smoke Detectors

Features:

- Package: black epoxy

- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

Very small package: (LxWxH) 3.2 mm x 1.6 mm x 1 mm

- High optical total power

UL version available (ordering code & test conditions on request)

Ordering Information

Туре	Irradiance 1)	Irradiance 1) typ.	Ordering Code
	$I_{p} = 70 \text{ mA}; t_{p} = 20 \text{ ms}$ E_{e}	$I_{\rm F} = 70 \text{ mA}; t_{\rm p} = 20 \text{ ms}$ $E_{\rm e}$	
SFH 4056	2.5 12.5 mW/cm ²	6 mW/cm²	Q65111A2992
SFH 4056-NP	2.5 8.0 mW/cm ²	6 mW/cm ²	Q65111A9688

 E_a measured in the near field with a detector (7.2 mm diameter) in 20 mm distance (Ω = 0.1 sr) to the device surface



		- 41
M	avimum	Ratings
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$T_{\Lambda} = 25 ^{\circ}$)
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Parameter	Symbol		Values
Operating temperature	T _{op}	min.	-40 °C
	ор	max.	85 °C
Storage temperature	T _{stg}	min.	-40 °C
	3.9	max.	85 °C
Reverse voltage ²⁾	V_R	max.	12 V
Forward current	I _F	max.	70 mA
Surge current	I _{FSM}	max.	0.7 A
$t_p \le 300 \ \mu s; \ D = 0$			
Power consumption	P _{tot}	max.	140 mW
ESD withstand voltage	V _{ESD}	max.	2 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	200		



Characteristics

 $I_F = 70$ mA; $t_p = 20$ ms; $T_A = 25$ °C

Parameter	Symbol	Values	
Peak wavelength	$\lambda_{\sf peak}$	typ.	860 nm
Centroid wavelength	$\lambda_{ ext{centroid}}$	typ.	850 nm
Spectral bandwidth at 50% I _{rel,max}	Δλ	typ.	30 nm
Half angle	φ	typ.	22 °
Dimensions of active chip area	L×W	typ.	0.2 x 0.2 mm x mm
Rise time (10% / 90%) $I_F = 70 \text{ mA}; R_L = 50 \Omega$	t _r	typ.	12 ns
Fall time (10% / 90%) $I_F = 70 \text{ mA}; R_L = 50 \Omega$	t _f	typ.	12 ns
Forward voltage	V_{F}	typ. max.	1.6 V 2 V
Forward voltage $I_F = 500 \text{ mA}$; $t_p = 100 \text{ µs}$	V_{F}	typ.	2.4 V
Reverse current ²⁾ V _R = 5 V	I _R	max. typ.	10 μA 0.01 μA
Total radiant flux 3)	Фе	typ.	40 mW
Radiant intensity	l _e	min. typ.	16 mW/sr 35 mW/sr
Temperature coefficient of brightness	TC,	typ.	-0.5 % / K
Temperature coefficient of voltage	TC _v	typ.	-0.7 mV / K
Temperature coefficient of wavelength	$TC_{_{\lambda}}$	typ.	0.3 nm / K
Thermal resistance junction ambient real 4)	R_{thJA}	max.	540 K / W
Thermal resistance junction solder point real 5)	R_{thJS}	max.	360 K / W

Radiant Intensity measured with a detector (11.3 mm diameter) in 100 mm distance (Ω = 0.01 sr) to the device surface



Brightness Groups

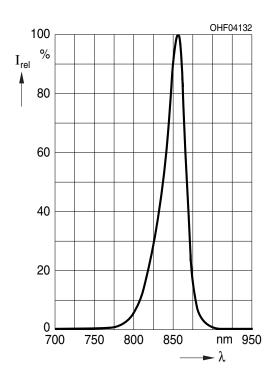
Group	Irradiance ¹⁾ $I_F = 70 \text{ mA}; t_p = 20 \text{ ms}$ min. E_e	Irradiance ¹⁾ $I_{F} = 70 \text{ mA; } t_{p} = 20 \text{ ms}$ $max.$ E_{e}
N	2.5 mW/cm²	5.0 mW/cm ²
P	4.0 mW/cm²	8.0 mW/cm ²
Q	6.3 mW/cm²	12.5 mW/cm²

Only one group in one packing unit (variation lower 2:1).

 $E_{\rm e}$ measured in the near field with a detector (7.2 mm diameter) in 20 mm distance (Ω = 0.1 sr) to the device surface

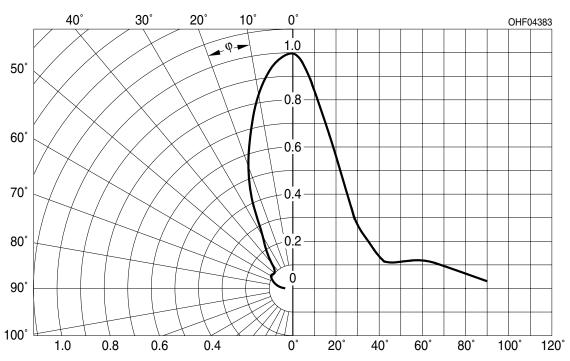
Relative Spectral Emission 6), 7)

$$I_{rel} = f(\lambda); I_{F} = 70 \text{ mA}; t_{p} = 20 \text{ ms}$$



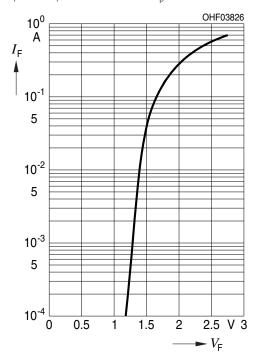
Radiation Characteristics 6), 7)





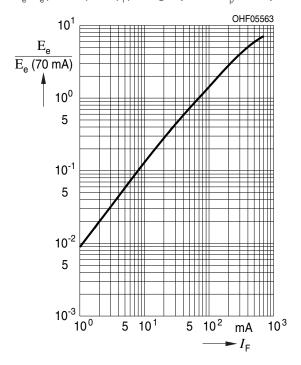
Forward current 6), 7)

 $I_F = f(V_F)$; single pulse; $t_p = 100 \mu s$



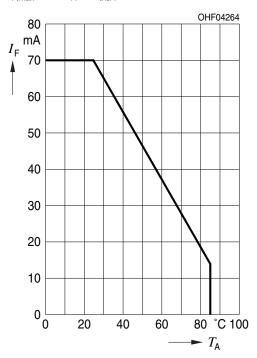
Irradiance 6), 7)

 $\rm E_e/E_e(70mA) = f(I_F);$ single pulse ; $\rm t_p = 25~\mu s$



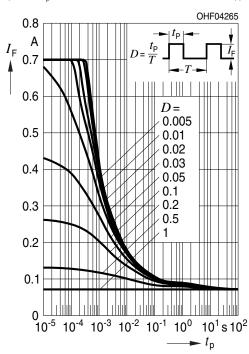
Max. Permissible Forward Current

$$I_{F,max} = f(T_A); R_{thJA} = 540 K/W$$



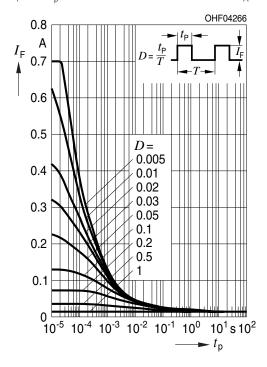
Permissible Pulse Handling Capability

 $I_F = f(t_p)$; duty cycle D = parameter; $T_A = 25$ °C

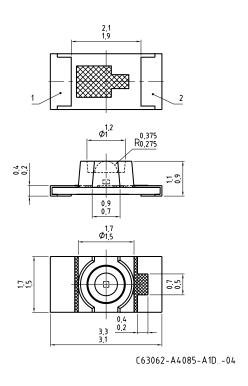


Permissible Pulse Handling Capability

 $I_F = f(t_p)$; duty cycle D = parameter; $T_A = 85$ °C



Dimensional Drawing 8)

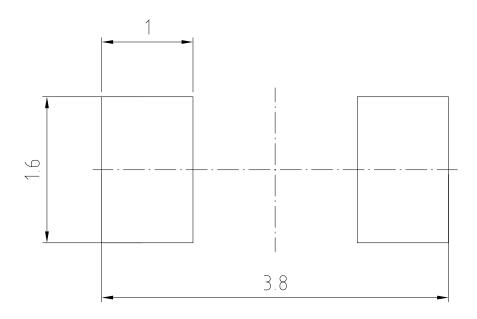


Approximate Weight: 5.3 mg

Package marking: Anode

Pin	Description
1	Cathode
2	Anode

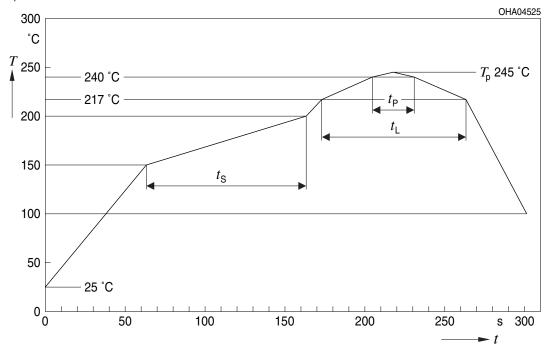
Recommended Solder Pad 8)



E062.3010.78-02

Reflow Soldering Profile

Product complies to MSL Level 3 acc. to JEDEC J-STD-020E



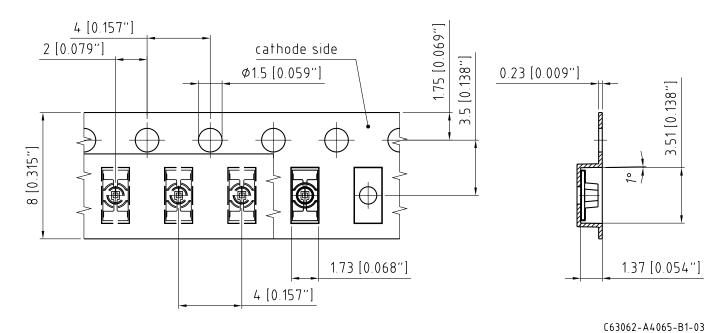


SFH 4056

Profile Feature	Symbol	Pb Minimum	-Free (SnAgCu) Ass Recommendation	sembly Maximum	Unit
Ramp-up rate to preheat*) 25 °C to 150 °C		William	2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t _s	60	100	120	S
Ramp-up rate to peak*) T _{Smax} to T _P			2	3	K/s
Liquidus temperature	T _L		217		°C
Time above liquidus temperature	t _L		80	100	S
Peak temperature	T _P		245	260	°C
Time within 5 °C of the specified peak temperature T _P - 5 K	t _P	10	20	30	S
Ramp-down rate* T _p to 100 °C			3	6	K/s
Time 25 °C to T _P				480	S

All temperatures refer to the center of the package, measured on the top of the component

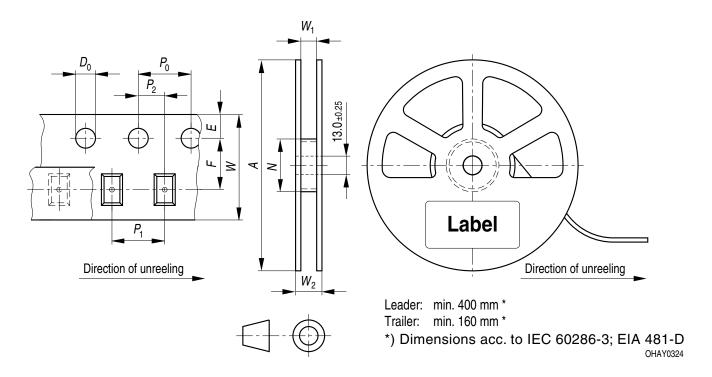
Taping 8)





^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Tape and Reel 9)



Reel dimensions [mm]

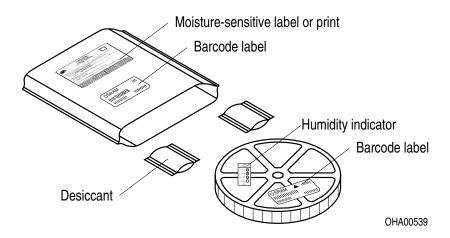
A	W	N_{min}	W ₁	$W_{2 max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	2000



Barcode-Product-Label (BPL)



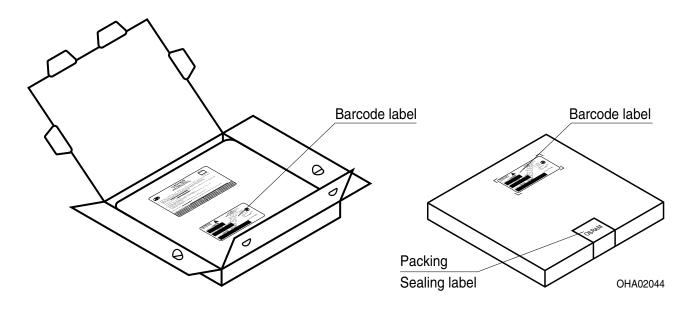
Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Transportation Packing and Materials 8)



Dimensions of transportation box in mm

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the LED specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. As is also true when viewing other bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

For further application related informations please visit www.osram-os.com/appnotes



Disclaimer

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

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Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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Glossary

- Irradiance: Measured at a solid angle of $\Omega = 0.1 \text{ sr}$
- Reverse Operation: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Total radiant flux: Measured with integrating sphere.
- Thermal resistance: junction ambient, mounted on PC-board (FR4), padsize 5 mm² each
- Thermal resistance: junction soldering point, of the device only, mounted on an ideal heatsink (e.g. metal block)
- Typical Values: Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Testing temperature: $T_A = 25^{\circ}C$
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ⁹⁾ **Tape and Reel**: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



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